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September 9, 2003

Attorney Docket No.: Intel 10559-857001 / P17305

Mail Stop Patent Application

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Presented for filing is a new original patent application of:

Applicant: SARAH E. KIM, BOB MARTELL, DAVE AYERS, R. SCOTT LIST,

PETER MOON AND STEVEN TOWLE

BOSTON

DALLAS

Title:

THICK METAL LAYER INTEGRATED PROCESS FLOW TO

IMPROVE POWER DELIVERY AND MECHANICAL BUFFERING

DELAWARE NEW YORK

SAN DIEGO

Assignee: Intel Corporation

SILICON VALLEY

Enclosed are the following papers, including those required to receive a filing date

TWIN CITIES WASHINGTON, DC under 37 CFR §1.53(b):

	Pages
Specification	17
Claims	6
Abstract	1
Declaration	[To be Filed at a Later Date]
Drawing s (inform	al) 14

Enclosures:

- New disclosure information, including: Information disclosure statement, 2 pages. PTO-1449, 1 page. References, 1 item.

- Postcard.

Basic filing fee	\$0
Total claims in excess of 20 times \$18	\$0
Independent claims in excess of 3 times \$84	\$0
Fee for multiple dependent claims	\$0
Total filing fee:	\$0

CERTIFICATE OF MAILING BY EXPRESS MAIL

Express Mail Label No._____ EV 348187719 US

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Date of Deposit

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Commissioner for Patents September 9, 2003 Page 2

Under 37 CFR §1.53(f), no filing fee is being paid at this time.

If this application is found to be incomplete, or if a telephone conference would otherwise be helpful, please call the undersigned at (858) 678-5070.

Kindly acknowledge receipt of this application by returning the enclosed postcard.

Please direct all correspondence to the following:

20985

PTO Customer Number

Respectfully submitted,

/BY

ALEX CHEN REG. NO. 45,591

Scott C. Harris Reg. No. 32,030

Attorneys for Intel Corporation

Enclosures SCH/cla 10327968.doc